PbS near-infrared detector Line array bare chip thin-film encapsulated



Features

- Thin-film encapsulation
- Very high sensitivity
- Suitable for automated wire-bonding

Applications

- NIR spectroscopy
- Fire and spark detection
- Flame and moisture monitoring

Electrical and optical characteristics per pixel

Element	Peak wave-	20% cut-off	Peak D*		Time constant	Dark resistance
temperature	length λ _P	wavelength	(620 Hz, 1 Hz)		[µs]	R_D [M Ω]
[°C]	[µm]	λ _C [μm]	[cm·Hz ^½ /W]			
	Тур.	Тур.	Тур.	Min.	Тур.	
22	2.7	2.9	$1 \cdot 10^{11}$	$0.5 \cdot 10^{11}$	200	3 - 30*

- Measured with 1550 nm LED, incident power 16 μW/cm²
- Measured in a voltage divider circuit with 50 V/mm
- Photo responsivity and detectivity are measured with constant load resistance ($R_L = 1 \text{ M}\Omega$) and calculated for matched resistance

Possible mechanical characteristics

Number of pixels 1 - 512
 Minimum pixel width 20 μm
 Minimum pixel height 20 μm
 Minimum pixel pitch 50 μm
 Minimal chip length 3000 μm
 Minimal chip height 3000 μm

Please contact us for an individual design: info@hertzstueck.de





^{*}depends on pixel geometry

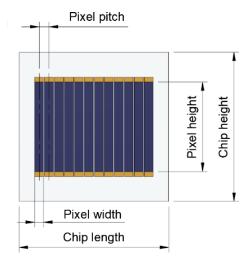
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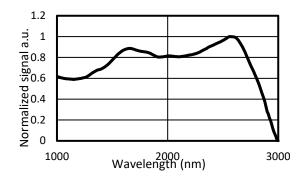
A brand of BASF - We create chemistry

Exemplary mechanical characteristics

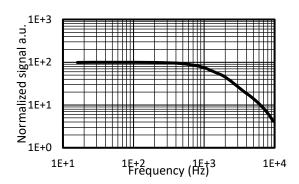
Type No.	Number of	Pixel	Pixel width	Pixel height	Operating
	Pixels	pitch	[µm]	[µm]	temperature
		[µm]			[°C]
PbS_Arr_256_0050_0040x0380	256	50	40 x 380		-30 to +70



Typical spectral response per pixel



Typical frequency response per pixel



trinamiX GmbH Industriestr. 35 Germany

PbS near-infrared detector Line array bare chip



Die attach

- Use clean, soft rubber tip for pick and place handling
- UV-curing is not suitable due to permanent damage by UV light exposure
- Element temperature should never exceed +70°C

Wire-bonding

- Electrodes are optimized for room temperature Al-wire-bonding
- Element temperature should never exceed +70°C

Options

- Individual housing
- Bonding onto PCB
- Integrated optics

Handling

- Active area is scratch sensitive, protect top surface from any mechanical contact
- Ensure dust-free environment for device handling
- Operating temperature: -30°C to +70°C

Regulatory

For the use of Hertzstück™ PbS and PbSe infrared photodetectors in medical devices, monitoring and control instruments and consumer applications RoHS exemptions apply.

For automotive applications Hertzstück™ PbS and PbSe infrared photodetectors fall under ELV exemption.

Storage

- Storage temperature: -55°C to +70°C
- Exposure to UV light results in permanent damage
- · Prevent exposure to UV and visible light

